

Figure 1. Molecular structures and thermogravimetric analysis of $[AlMe_2(DMP)]$ (**1**, DMAD) $[Al(NMe_2)_2(DMP)]$ (**2**), $[Al(NEt_2)_2(DMP)]$ (**3**, BDEADA), $[Al(N^iPr_2)_2(DMP)]$ (**4**) from room temperature to 550 °C. The inset shows the isothermal TGA at given temperatures over a period of 100 min of the respective compound.

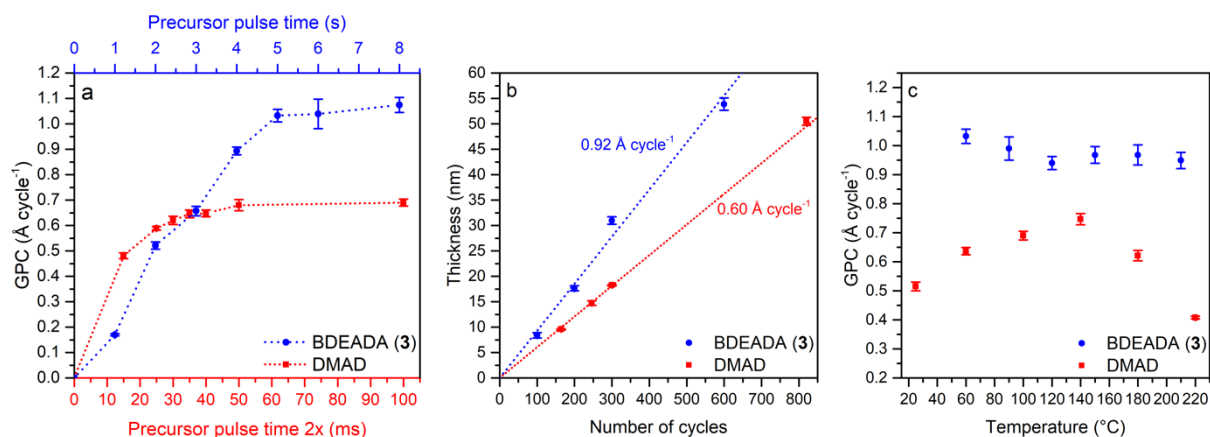


Figure 2. ALD characteristics of the PEALD processes employing DMAD (**1**) and BDEADA (**3**) as precursor: a) precursor saturation study at 60 °C; b) linear dependence of the thin film thickness vs. cycle number at 60 °C; c) temperature dependency of the growth rate.

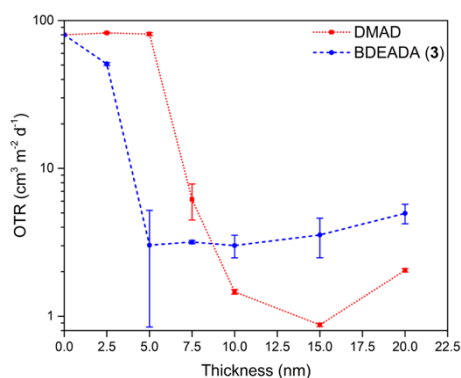


Figure 3. Oxygen transmission rates (OTR) of Al_2O_3 thin films of different thicknesses, grown on 23 μm thick PET foil via PEALD at 60 °C using DMAD (**1**) and BDEADA (**3**) as precursor.